**Product data sheet** 

# 1. General description

The HEF40175B is a quad positive edge triggered D-type flip-flop with four data (Dn) inputs, common clock (CP) and asynchronous master reset ( $\overline{\text{MR}}$ ) inputs, and complementary Qn and  $\overline{\text{Qn}}$  outputs. When  $\overline{\text{MR}}$  is HIGH data at the D-input that meets the set-up and hold time requirements on the LOW-to-HIGH clock transition will be stored in the flip-flop and appear at the Q output. When LOW,  $\overline{\text{MR}}$  resets all flip-flops (Qn = LOW,  $\overline{\text{Qn}}$  = HIGH), independent of CP and Dn. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of  $V_{DD}$ .

## 2. Features and benefits

- Wide supply voltage range from 3.0 V to 15.0 V
- CMOS low power dissipation
- · High noise immunity
- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- · Standardized symmetrical output characteristics
- · Complies with JEDEC standard JESD 13-B
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85°C and from -40 °C to +125 °C

# 3. Applications

- Shift registers
- Buffer/storage register
- · Pattern generator

# 4. Ordering information

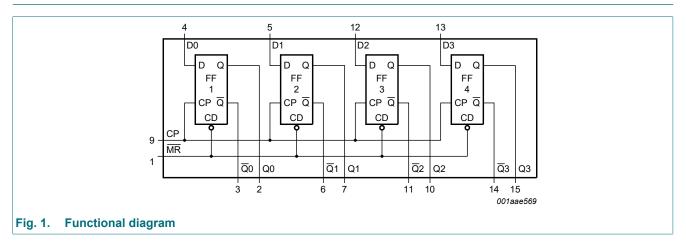
### **Table 1. Ordering information**

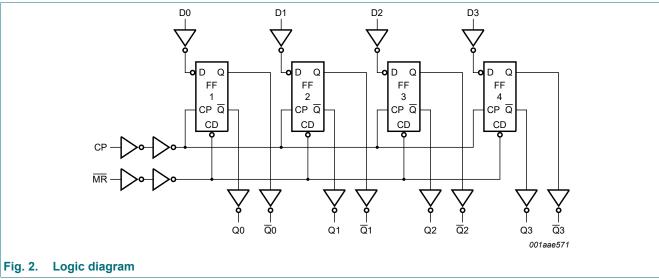
Type number	Package					
	Temperature range	Name	Description	Version		
HEF40175BT	-40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	<u>SOT109-1</u>		
HEF40175BTT	-40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	<u>SOT403-1</u>		



Quad D-type flip-flop

# 5. Functional diagram



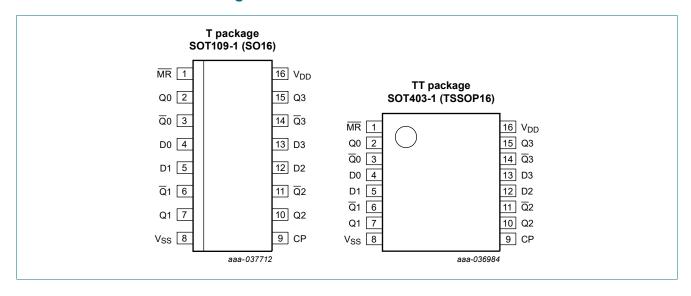


**Product data sheet** 

**Quad D-type flip-flop** 

# 6. Pinning information

### 6.1. Pinning



## 6.2. Pin description

Table 2. Pin description

Symbol	Pin	Description
MR	1	master reset input (active LOW)
Q0, Q1, Q2, Q3	2, 7, 10, 15	buffered output
$\overline{\mathbb{Q}}$ 0, $\overline{\mathbb{Q}}$ 1, $\overline{\mathbb{Q}}$ 2, $\overline{\mathbb{Q}}$ 3	3, 6, 11, 14	complementary buffered output
D0, D1, D2, D3	4, 5, 12, 13	data input
V <sub>SS</sub>	8	ground supply voltage
СР	9	clock input (LOW-to-HIGH edge-triggered)
$V_{DD}$	16	supply voltage

# 7. Functional description

#### Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care;

 $\uparrow$  = positive-going transition;  $\downarrow$  = negative-going transition.

Input			Output		
СР	Dn	MR	Qn	<b>Q</b> n	
$\uparrow$	Н	Н	Н	L	
$\uparrow$	L	Н	L	Н	
$\downarrow$	Х	Н	no change	no change	
X	X	L	L	Н	

**Quad D-type flip-flop** 

# 8. Limiting values

### **Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{DD}$	supply voltage		-0.5	+18	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 \text{ V or } V_{I} > V_{DD} + 0.5 \text{ V}$	-	±10	mA
VI	input voltage		-0.5	V <sub>DD</sub> + 0.5	V
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{DD}$ + 0.5 V	-	±10	mA
I <sub>I/O</sub>	input/output current		-	±10	mA
I <sub>DD</sub>	supply current		-	50	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>amb</sub>	ambient temperature		-40	+125	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$ [1]	-	500	mW
Р	power dissipation	per output	-	100	mW

<sup>[1]</sup> For SOT109-1 (SO16) package:  $P_{tot}$  derates linearly with 12.4 mW/K above 110 °C. For SOT403-1 (TSSOP16) package:  $P_{tot}$  derates linearly with 8.5 mW/K above 91 °C.

# 9. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{DD}$	supply voltage		3	-	15	V
VI	input voltage		0	-	$V_{DD}$	V
T <sub>amb</sub>	ambient temperature	in free air	-40	-	+125	°C
Δt/ΔV	input transition rise and fall rate	V <sub>DD</sub> = 5 V	-	-	3.75	μs/V
		V <sub>DD</sub> = 10 V	-	-	0.5	μs/V
		V <sub>DD</sub> = 15 V	-	-	0.08	μs/V

Quad D-type flip-flop

# 10. Static characteristics

#### **Table 6. Static characteristics**

 $V_{SS} = 0 \ V$ ;  $V_I = V_{SS}$  or  $V_{DD}$  unless otherwise specified.

Symbol	Parameter	Conditions	$V_{DD}$	T <sub>amb</sub> = -40 °C		T <sub>amb</sub> = +25 °C		T <sub>amb</sub> = +85 °C		T <sub>amb</sub> = +125 °C		Unit
				Min	Max	Min	Max	Min	Max	Min	Max	
$V_{IH}$	HIGH-level	I <sub>O</sub>   < 1 μΑ	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V <sub>IL</sub>	LOW-level input	I <sub>O</sub>   < 1 μΑ	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V <sub>OH</sub>	HIGH-level	I <sub>O</sub>   < 1 μΑ	5 V	4.95	-	4.95	-	4.95	-	4.95	-	V
	output voltage		10 V	9.95	-	9.95	-	9.95	-	9.95	-	V
			15 V	14.95	-	14.95	-	14.95	-	14.95	-	V
V <sub>OL</sub>	LOW-level	I <sub>O</sub>   < 1 μΑ	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V
	output voltage		10 V	-	0.05	-	0.05	-	0.05	-	0.05	V
			15 V	-	0.05	-	0.05	-	0.05	-	0.05	V
I <sub>OH</sub>	HIGH-level	V <sub>O</sub> = 2.5 V	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
	output current	V <sub>O</sub> = 4.6 V	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		V <sub>O</sub> = 9.5 V	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V <sub>O</sub> = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
I <sub>OL</sub>	LOW-level	V <sub>O</sub> = 0.4 V	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
	output current	V <sub>O</sub> = 0.5 V	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V <sub>O</sub> = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
I <sub>I</sub>	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ
I <sub>DD</sub>	supply current	all valid input	5 V	-	1.0	-	1.0	-	30	-	30	μΑ
		combinations;  I <sub>O</sub>  = 0 A	10 V	-	2.0	-	2.0	-	60	-	60	μA
		IIOI- O Y	15 V	-	4.0	-	4.0	-	120	-	120	μA
Cı	input capacitance		-	-	-	-	7.5	-	-	-	-	pF

Quad D-type flip-flop

# 11. Dynamic characteristics

### **Table 7. Dynamic characteristics**

 $V_{SS} = 0 \text{ V}$ ;  $T_{amb} = 25 \text{ °C}$  unless otherwise specified; for test circuit see Fig. 4.

Symbol	Parameter	Conditions	$V_{DD}$	Extrapolation formula[1]	Min	Тур	Max	Unit
t <sub>PHL</sub>	HIGH to LOW	CP to Qn or Qn;	5 V	53 ns + (0.55 ns/pF) C <sub>L</sub>	-	80	160	ns
	propagation delay	see Fig. 3	10 V	24 ns + (0.23 ns/pF) C <sub>L</sub>	-	35	70	ns
			15 V	17 ns + (0.16 ns/pF) C <sub>L</sub>	-	25	50	ns
		MR to Qn; see Fig. 3	5 V	48 ns + (0.55 ns/pF) C <sub>L</sub>	-	75	155	ns
			10 V	19 ns + (0.23 ns/pF) C <sub>L</sub>	-	30	65	ns
			15 V	17 ns + (0.16 ns/pF) C <sub>L</sub>	-	25	50	ns
t <sub>PLH</sub>	LOW to HIGH	CP to Qn or Qn;	5 V	43 ns + (0.55 ns/pF) C <sub>L</sub>	-	70	140	ns
	propagation delay	see Fig. 3	10 V	19 ns + (0.23 ns/pF) C <sub>L</sub>	-	30	65	ns
			15 V	17 ns + (0.16 ns/pF) C <sub>L</sub>	-	25	45	ns
		MR to Qn; see Fig. 3	5 V	43 ns + (0.55 ns/pF) C <sub>L</sub>	-	70	140	ns
			10 V	19 ns + (0.23 ns/pF) C <sub>L</sub>	-	30	65	ns
			15 V	17 ns + (0.16 ns/pF) C <sub>L</sub>	-	25	50	ns
t <sub>t</sub>	transition time	see Fig. 3	5 V	10 ns + (1.00 ns/pF) C <sub>L</sub>	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF) C <sub>L</sub>	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF) C <sub>L</sub>	-	20	40	ns
t <sub>su</sub>	set-up time	Dn to CP; see Fig. 3	5 V		60	30	-	ns
			10 V		20	10	-	ns
			15 V		15	5	-	ns
t <sub>h</sub>	hold time	Dn to CP; see Fig. 3	5 V		+25	-5	-	ns
			10 V		10	0	-	ns
			15 V		10	0	-	ns
t <sub>W</sub>	pulse width	CP input LOW;	5 V		90	45	-	ns
		minimum pulse width; see Fig. 3	10 V		35	15	-	ns
		see <u>Fig. 5</u>	15 V		25	10	-	ns
		MR input LOW;	5 V		80	40	-	ns
		minimum pulse width; see Fig. 3	10 V		30	15	-	ns
		see <u>r ig. 5</u>	15 V		20	10	-	ns
t <sub>rec</sub>	recovery time	MR input; see Fig. 3	5 V		0	-30	-	ns
			10 V		0	-20	-	ns
			15 V		0	-15	-	ns
f <sub>max</sub>	maximum frequency		5 V		5	11	-	MHz
			10 V		15	30	-	MHz
			15 V		20	45	-	MHz

<sup>[1]</sup> The typical values of the propagation delay and transition times are calculated from the extrapolation formula shown ( $C_L$  in pF).

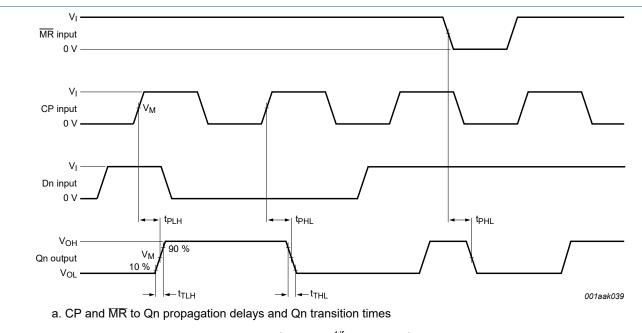
**Quad D-type flip-flop** 

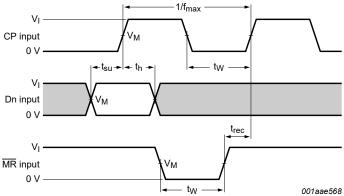
Table 8. Dynamic power dissipation P<sub>D</sub>

 $P_D$  can be calculated from the formulas shown.  $V_{SS}$  = 0 V;  $t_r$  =  $t_f$  ≤ 20 ns;  $T_{amb}$  = 25 °C.

Symbol	Parameter	$V_{DD}$	Typical formula for P <sub>D</sub> (μW)	where:
$P_D$	dynamic power dissipation	5 V	1 (0 1) 00	f <sub>i</sub> = input frequency in MHz;
		10 V		f <sub>o</sub> = output frequency in MHz; C <sub>L</sub> = output load capacitance in pF;
		15 V	D 00500 ( . E/( 0 \ ) / /	V <sub>DD</sub> = supply voltage in V;
				$\Sigma(f_0 \times C_L)$ = sum of the outputs.

### 11.1. Waveforms and test circuit





b. Minimum pulse widths for CP and  $\overline{MR}$ ,  $\overline{MR}$  to CP recovery time, and set-up and hold time for Dn to CP  $V_{OH}$  and  $V_{OL}$  are typical output voltage levels that occur with the output load.

Set-up and hold times are shown as positive values but may be specified as negative values.

The shaded area are where input changes result in predicable output performance.

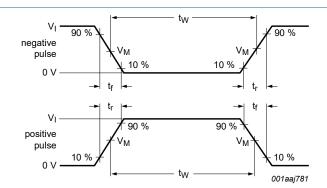
Measurement points are given in <u>Table 9</u>.

### Fig. 3. Waveforms showing switching times

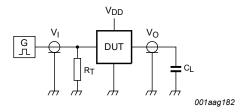
## Quad D-type flip-flop

**Table 9. Measurement points** 

Supply voltage	Input	Output	
$V_{DD}$	V <sub>M</sub>	V <sub>M</sub>	
5 V to 15 V	0.5 × V <sub>DD</sub>	0.5 × V <sub>DD</sub>	



#### a. Input waveforms



#### b .Test circuit

Test and measurement data is given in <u>Table 10</u>.

Definitions test circuit:

 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator;

C<sub>L</sub> = Load capacitance including jig and probe capacitance.

### Fig. 4. Test circuit for measuring switching times

Table 10. Measurement points and test data

Supply voltage	Input	Load	
$V_{DD}$	V <sub>I</sub>	t <sub>r</sub> , t <sub>f</sub>	CL
5 V to 15 V	V <sub>SS</sub> or V <sub>DD</sub>	≤ 20 ns	50 pF

**Quad D-type flip-flop** 

# 12. Package outline

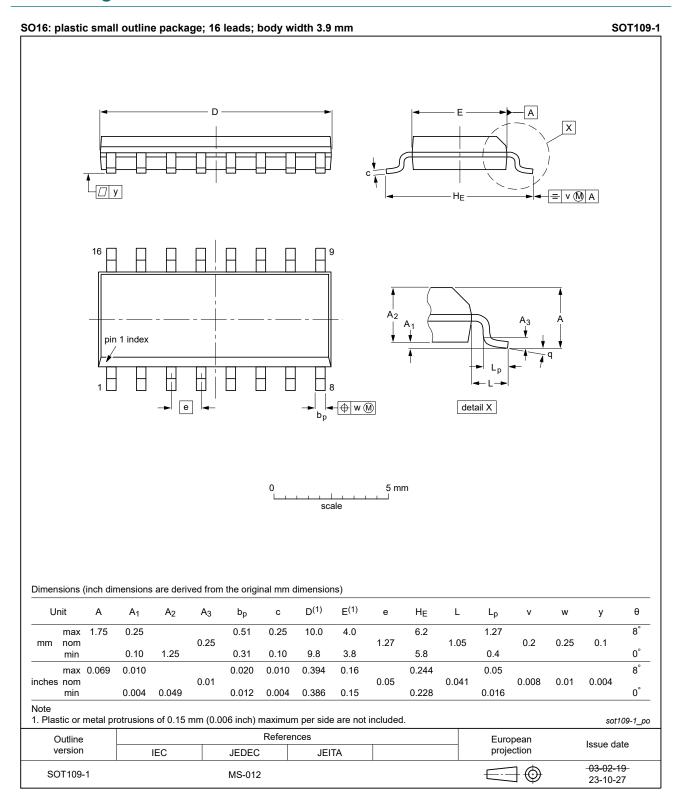


Fig. 5. Package outline SOT109-1 (SO16)

### Quad D-type flip-flop

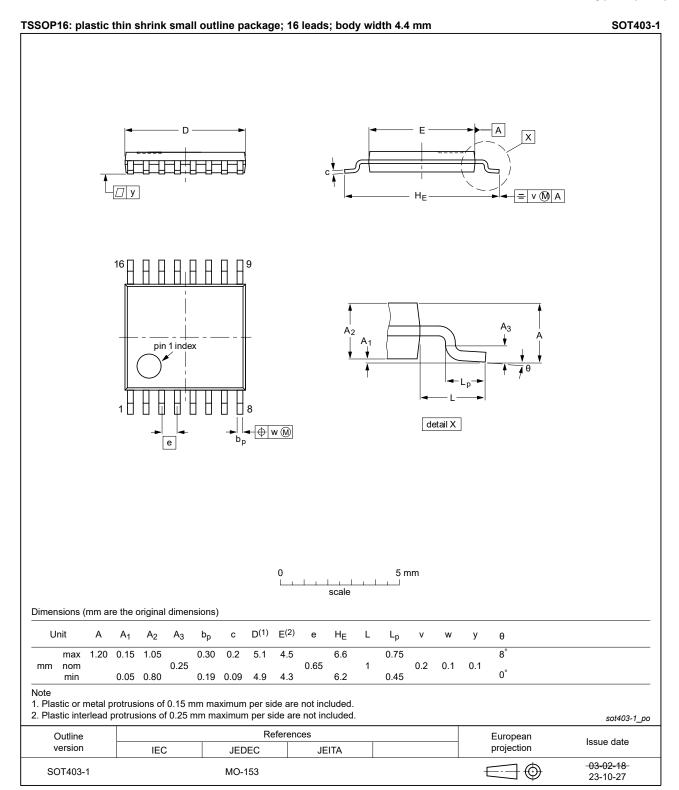


Fig. 6. Package outline SOT403-1 (TSSOP16)

Quad D-type flip-flop

# 13. Abbreviations

#### **Table 11. Abbreviations**

Acronym	Description
ANSI	American National Standards Institute
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
НВМ	Human Body Model
JEDEC	Joint Electron Device Engineering Council

# 14. Revision history

### Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
HEF40175B v.11	20240808	Product data sheet	-	HEF40175B v.10.1			
Modifications:	<ul> <li>Section 2: ESD specification updated according to the latest JEDEC standard.</li> <li>Fig. 5, Fig. 6: Aligned SO and TSSOP package outline drawings to JEDEC MS-012 and MO-153</li> </ul>						
HEF40175B v.10.1	20231020	Product data sheet	-	HEF40175B v.9			
Modifications:	<ul> <li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> <li>Section 1 and Section 2 updated.</li> <li>Table 4: Derating values for Ptot total power dissipation updated.</li> </ul>						
HEF40175B v.9	20160321	Product data sheet	-	HEF40175B v.8			
Modifications:	Type number	er HEF40175BP (SOT38-4	) removed.				
HEF40175B v.8	20111121	Product data sheet	-	HEF40175B v.7			
Modifications:	<ul><li>Legal pages</li><li>Changes in</li></ul>	s updated. "General description", "Fe	atures and benefit	s" and "Applications".			
HEF40175B v.7	20110503	Product data sheet	-	HEF40175B v.6			
HEF40175B v.6	20101214	Product data sheet	-	HEF40175B v.5			
HEF40175B v.5	20100105	Product data sheet	-	HEF40175B v.4			
HEF40175B v.4	20090813	Product data sheet	-	HEF40175B_CNV v.3			
HEF40175B_CNV v.3	19950101	Product specification	-	HEF40175B_CNV v.2			
HEF40175B_CNV v.2	19950101	Product specification	-	-			

**Product data sheet** 

#### **Quad D-type flip-flop**

# 15. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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- Please consult the most recently issued document before initiating or completing a design.
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